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APPLICATION NO.	F	ILING DATE	FIRST NAMED INVENTOR .	ATTORNEY DOCKET	NO. CONFIRMATION NO.	
10/648,586	6 08/26/2003		Efren M. Lacap	408204	4089	
30955	7590	06/23/2005		E	EXAMINER	
LATHRO			JOHNSON, JONATHAN J			
4845 PEAR SUITE 300	L EAST C	CIRCLE		ART UNIT	PAPER NUMBER	
BOULDER, CO 80301				1725		

DATE MAILED: 06/23/2005

Please find below and/or attached an Office communication concerning this application or proceeding.

			[A						
		Application No.	Applicant(s)						
	Office Action Summary	10/648,586	LACAP ET AL.						
•	Office Action Summary	Examiner	Art Unit						
	The MAII INC DATE of this somewhile	Jonathan Johnson	1725						
The MAILING DATE of this communication appears on the cover sheet with the correspondence address Period for Reply									
THE I - Exter after - If the - If NO - Failu Any	ORTENED STATUTORY PERIOD FOR MAILING DATE OF THIS COMMUNICATION of time may be available under the provisions of SIX (6) MONTHS from the mailing date of this communication for reply specified above is less than thirty (30) of period for reply is specified above, the maximum status re to reply within the set or extended period for reply with reply received by the Office later than three months after the patent term adjustment. See 37 CFR 1.704(b).	ATION. 37 CFR 1.136(a). In no event, however, rication. days, a reply within the statutory minimum ory period will apply and will expire SIX (6), by statute, cause the application to become.	nay a reply be timely filed of thirty (30) days will be considered timely. MONTHS from the mailing date of this communication me ABANDONED (35 U.S.C. § 133).	on.					
Status									
1)⊠	Responsive to communication(s) filed	on <u>4-25-05</u> .							
2a) <u></u> ☐	This action is FINAL . 2b)⊠ This action is non-final.								
3)	Since this application is in condition for			S					
	closed in accordance with the practice	under Ex parte Quayle, 1950	O.D. 11, 455 O.G. 215.						
Dispositi	on of Claims								
•	Claim(s) 1-17 is/are pending in the app								
	4a) Of the above claim(s) 12-17 is/are withdrawn from consideration.								
·	5) Claim(s) is/are allowed.								
•	6)⊠ Claim(s) <u>1-11</u> is/are rejected. 7)□ Claim(s) is/are objected to.								
8) Claim(s) 1-17 are subject to restriction and/or election requirement.									
Applicati	on Papers			:					
	The specification is objected to by the	- - - - - - -	-	:					
10) The drawing(s) filed on is/are: a) accepted or b) objected to by the Examiner.									
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).									
Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d).									
11)	The oath or declaration is objected to be	y the Examiner. Note the atta	ached Office Action or form PTO-152.						
Priority u	ınder 35 U.S.C. § 119								
12)	Acknowledgment is made of a claim fo	r foreign priority under 35 U.S	S.C. § 119(a)-(d) or (f).						
a)[☐ All b)☐ Some * c)☐ None of:								
	1. Certified copies of the priority do2. Certified copies of the priority do								
	•		been received in this National Stage						
	application from the International								
* 5	See the attached detailed Office action	for a list of the certified copies	s not received.						
Attachmen	t(s) e of References Cited (PTO-892)	4) 🔲 Inter	view Summary (PTO-413)						
2) Notice	e of Draftsperson's Patent Drawing Review (PTC	0-948) Pape	er No(s)/Mail Date						
•	mation Disclosure Statement(s) (PTO-1449 or P ⁻ r No(s)/Mail Date <u>8-26-03</u> .	7	ce of Informal Patent Application (PTO-152)						
.S. Patent and T		Office Action Summary	Part of Paper No./Mail Date 061	805 Ze					

Application/Control Number: 10/648,586

Art Unit: 1725

DETAILED ACTION

Election/Restrictions

Applicant's arguments are persuasive. The examiner will merge group 1a and 1b.

Claim Rejections - 35 USC § 102

The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

(a) the invention was known or used by others in this country, or patented or described in a printed publication in this or a foreign country, before the invention thereof by the applicant for a patent.

Claims 1-11 are rejected under 35 U.S.C. 102(a) as being anticipated by

Applicant's Admitted Prior Art (AAPA). AAPA teaches forming a socket on a first
surface of a microchip, such that the socket has predetermined physical dimensions
complementary to those of a microchip connection pad footprint occupied by at least one
contact pad area on the microchip (fig. 2, item 29), the socket presenting a conductive
base capable of bonding to solder; bonding solder to the conductive base to place a solder
bar in the socket and place the microchip in made-ready condition for installation. (fig. 2,
item 3a); wherein the microchip contains a silicon wafer and the step of forming the
socket comprises depositing an adhesion layer onto the wafer, and depositing underbump-metallization (UBM) material contacting the adhesion layer to complete formation
of the conductive base (figure 2, items 4, 28 and 29); wherein the step of depositing the
adhesion layer includes depositing a conductor selected from the group consisting of
aluminum, nickel-vanadium, titanium, tungsten and copper (specification, paragraph 7);

Application/Control Number: 10/648,586

Art Unit: 1725

wherein the step of depositing the UMB material includes depositing a conductor selected from at least one of titanium, tungsten, vanadium, tin, copper, aluminum, gold, silver, and lead (specification, paragraph 8); wherein the step of forming the socket includes the predetermined dimensions selected from the group consisting of rectangular, "E," "L," and "U" shapes (figure 2, side profile of item 29); wherein the step of forming the socket includes the physical dimensions selected from the group consisting of ring, square, and circular shapes (figure 2, top view of item 20a); , wherein the step of forming the socket includes the physical dimensions being complimentary to the solder bar having a planar rectilinear configuration (figure 2, side view of 20A); wherein the step of forming the socket includes the physical dimensions being complimentary to the solder bar having a planar curvilinear configuration (figure 2, top view of 20a); wherein the step of forming the socket includes the physical dimensions being complimentary to the solder bar having a planar curvilinear configuration (figure 2, item 3a); wherein the step of forming the socket further comprising a step of forming a passivation layer on substantially all of the first surface, exclusive of an area where the socket is located (figure 2, item 29); wherein the step of forming the passivation layer includes the steps of: applying one or more layers of passivation material to the entire first surface; and removing selected portions of the passivation material covering the area where the socket is to be located (figure 2, item 29); wherein the step of applying one or more layers of passivation material includes applying at least one layer selected from the group consisting of polysilicon, silicon dioxide, and benzocyclobutane (figure 2, item 28).

Application/Control Number: 10/648,586 Page 4

Art Unit: 1725

Conclusion

The prior art made of record and not relied upon is considered pertinent to applicant's disclosure.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Jonathan Johnson whose telephone number is 571-272-1177. The examiner can normally be reached on M-Th 7:30 AM-5:30 PM.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Tom Dunn can be reached on 571-272-1171. The fax phone number for the organization where this application or proceeding is assigned is 703-872-9306.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

Jonathan Johnson Primary Examiner Art Unit 1725